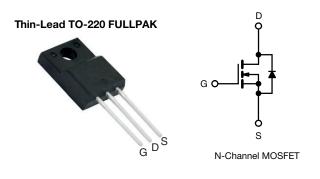
Vishay Siliconix



E Series Power MOSFET



PRODUCT SUMMARY					
V _{DS} (V) at T _J max.	550				
R _{DS(on)} max. (Ω) at 25 °C	V _{GS} = 10 V 0.243				
Q _g max. (nC)	66				
Q _{gs} (nC)	8				
Q _{gd} (nC)	14				
Configuration	Single				

FEATURES

- Low figure-of-merit (FOM) Ron x Qg
- Low input capacitance (Ciss)
- Reduced switching and conduction losses
- Low gate charge (Q_q)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Computing
 - PC silver box / ATX power supplies
- Lighting
 - Two stage LED lighting
- Consumer electronics
- · Applications using hard switched topologies
 - Power factor correction (PFC)
 - Two switch forward converter
 - Flyback converter
- Switch mode power supplies (SMPS)

ORDERING INFORMATION	
Package	Thin-Lead TO-220 FULLPAK
Lead (Pb)-free	SiHA15N50E-E3
Lead (Pb)-free and halogen-free	SiHA15N50E-GE3

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V _{DS}	500	v	
Gate-source voltage			V _{GS}	± 30	v	
Continuous drain current ($T_{,1} = 150 \text{ °C}$) ^e	V _{GS} at 10 V	T _C = 25 °C T _C = 100 °C		14.5		
Continuous drain current $(1_j = 150 \text{ C})^2$	VGS AL TO V	T _C = 100 °C	I _D	9.2	А	
Pulsed drain current ^a			I _{DM}	28		
Linear derating factor				1.25	W/°C	
Single pulse avalanche energy ^b			E _{AS}	136	mJ	
Maximum power dissipation			PD	33	W	
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C	
Drain-source voltage slope	$V_{DS} = 0 V \text{ to } 80 \% V_{DS}$		dV/dt	70	V/ns	
Reverse diode dV/dt ^d			av/ai	27	v/ns	
Soldering recommendations (peak temperature) ^c	for 10 s			300	°C	
Mounting torque	M3 screw			0.6	Nm	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b. V_{DD} = 50 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 3.1 A

c. 1.6 mm from case

d. $I_{SD} \leq I_D, \, dI/dt$ = 100 A/µs, starting T_J = 25 $^\circ C$

e. Limited by maximum junction temperature



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THERMAL RESISTANCE RAT	INGS							
PARAMETER	SYMBOL	TYP.		MAX.		UNIT		
Maximum junction-to-ambient	R _{thJA}	- 65						
Maximum junction-to-case (drain)	R _{thJC}	- 3.8				°C/W		
SPECIFICATIONS (T _J = 25 $^{\circ}$ C, u	unless otherwi	se noted)						
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT	
Static						•		
Drain-source breakdown voltage	V _{DS}	V _{GS} =	= 0 V, I _D =	250 µA	500	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C,	$I_D = 1 \text{ mA}$	-	0.62	-	V/°C
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D =	250 µA	2.0	-	4.0	V
			$V_{GS} = \pm 20$	V	-	-	± 100	nA
Gate-source leakage	IGSS	,	V _{GS} = ± 30	V	-	-	± 1	μA
Zero gata valtaga drain ourrant	1	V _{DS} =	= 500 V, V _G	_{iS} = 0 V	-	-	10	
Zero gate voltage drain current	IDSS	V _{DS} = 400 V	′, V _{GS} = 0 \	/, T _J = 125 °C	-	-	25	μA
Drain-source on-state resistance	R _{DS(on)}	$V_{GS} = 10 V$	l _i	_D = 7.5 A	-	0.243	0.280	Ω
Forward transconductance	9 _{fs}	V _{DS} :	= 30 V, I _D =	= 7.5 A	-	3.9	-	S
Dynamic						•		•
Input capacitance	C _{iss}	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 1 MHz		-	1162	-	pF	
Output capacitance	C _{oss}			-	51	-		
Reverse transfer capacitance	C _{rss}			-	7	-		
Effective output capacitance, energy related ^a	C _{o(er)}	$V_{DS} = 0$ V to 400 V, $V_{GS} = 0$ V		-	55	-		
Effective output capacitance, time related ^b	C _{o(tr)}			-	164	-		
Total gate charge	Qg			-	33	66	1	
Gate-source charge	Q _{gs}	$V_{GS} = 10 V$	I _D = 7.5	A, $V_{DS} = 400 V$	-	8	-	nC
Gate-drain charge	Q _{gd}				-	14	-	
Turn-on delay time	t _{d(on)}				-	15	30	
Rise time	t _r	V _{DD} =	V _{DD} = 400 V, I _D = 12 A,		-	24	48	
Turn-off delay time	t _{d(off)}	$V_{DD} = 400 \text{ V}, _{D} = 12 \text{ A},$ $V_{GS} = 10 \text{ V}, \text{ R}_{g} = 9.1 \Omega$		-	34	68	ns	
Fall time	t _f			-	18	36		
Gate input resistance	R _g	f = 1 MHz, open drain		-	0.85	-	Ω	
Drain-Source Body Diode Characteristi	cs							
Continuous source-drain diode current	١ _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	14.5	Λ	
Pulsed diode forward current	I _{SM}			-	-	28	A	
Diode forward voltage	V _{SD}	T _J = 25 °C	C, I _S = 7.5 /	A, V _{GS} = 0 V	-	-	1.2	V
Reverse recovery time	t _{rr}				-	265	-	ns
Reverse recovery charge	Q _{rr}	$T_{J} = 25 \ ^{\circ}C, \ I_{F} = I_{S} = 7.5 \ A, \\ dI/dt = 100 \ A/\mu s, \ V_{R} = 25 \ V$		-	3.2	-	μC	
Reverse recovery current	I _{RRM}			-	23	-	Α	

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

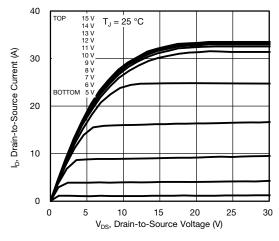


Fig. 1 - Typical Output Characteristics

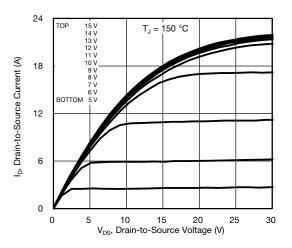


Fig. 2 - Typical Output Characteristics

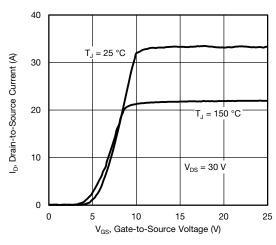


Fig. 3 - Typical Transfer Characteristics

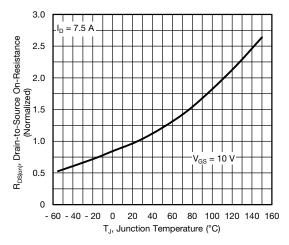


Fig. 4 - Normalized On-Resistance vs. Temperature

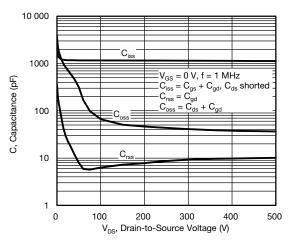


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

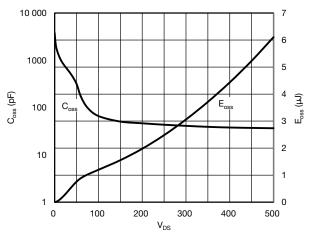


Fig. 6 - C_{oss} and E_{oss} vs. V_{DS}

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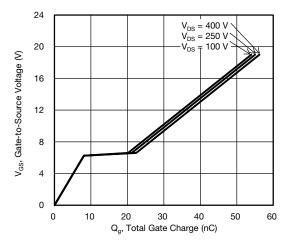


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

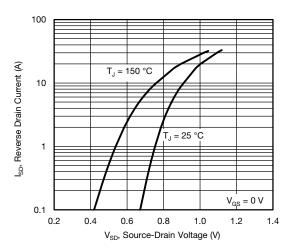
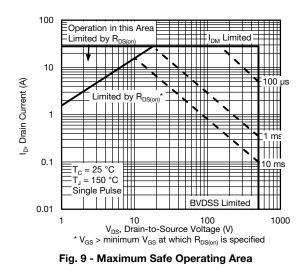


Fig. 8 - Typical Source-Drain Diode Forward Voltage



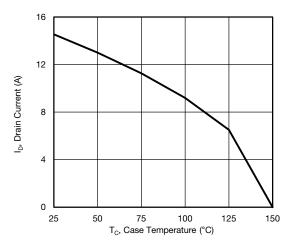


Fig. 10 - Maximum Drain Current vs. Case Temperature

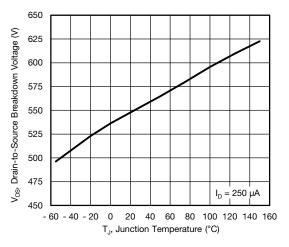
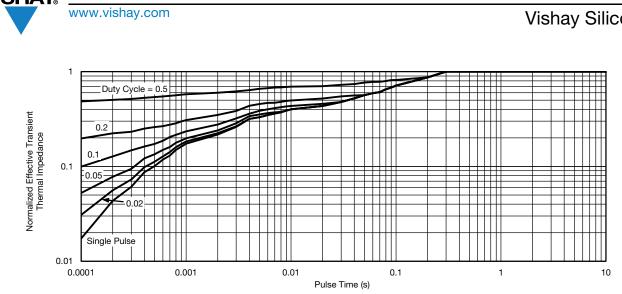


Fig. 11 - Temperature vs. Drain-to-Source Voltage

4





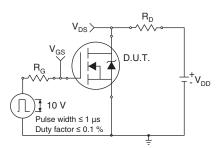


Fig. 13 - Switching Time Test Circuit

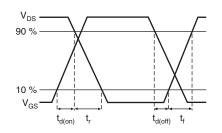


Fig. 14 - Switching Time Waveforms

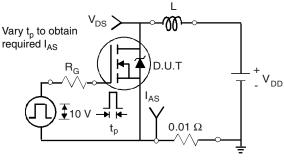


Fig. 15 - Unclamped Inductive Test Circuit

V_{DS} V_{DD} V_{DS} I_{AS}

Fig. 16 - Unclamped Inductive Waveforms

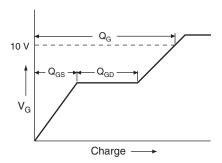


Fig. 17 - Basic Gate Charge Waveform

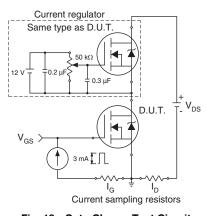


Fig. 18 - Gate Charge Test Circuit

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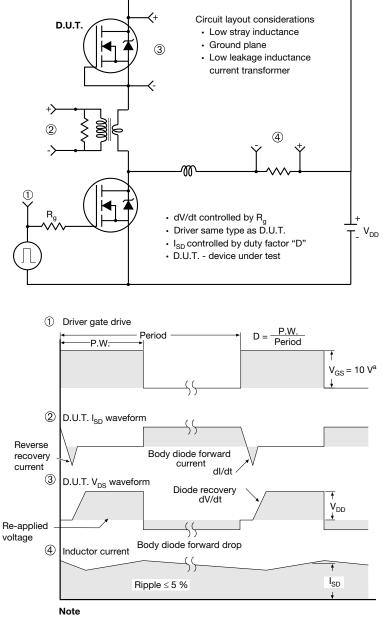
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SiHA15N50E

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Peak Diode Recovery dV/dt Test Circuit



a. $V_{GS} = 5 V$ for logic level devices

Fig. 19 - For N-Channel

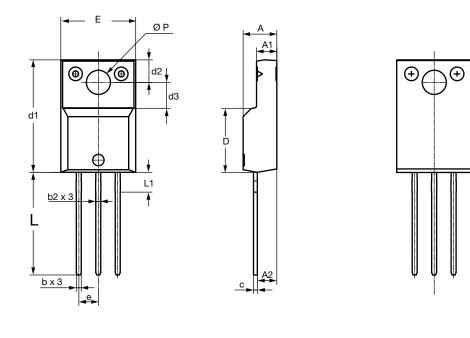
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TO-220 FULLPAK Thin Lead





		DIMEN	ISIONS	
SYMBOL	MILLIN	METERS	INC	HES
	MIN.	MAX.	MIN.	MAX.
А	4.30	4.70	0.169	0.185
A1	2.50	2.90	0.098	0.114
A2	2.40	2.80	0.094	0.110
b	0.60	0.80	0.024	0.031
b2	0.60	0.90	0.024	0.035
С	-	0.60	-	0.024
D	8.30	8.70	0.327	0.342
d1	14.70	15.30	0.579	0.602
d2	2.90	3.10	0.114	0.122
d3	3.30	3.70	0.130	0.146
E	9.70	10.30	0.382	0.406
е	2.50	2.70	0.098	0.106
L	13.40	13.80	0.528	0.543
L1	1.00	2.80	0.039	0.110
ØP	3.00	3.40	0.118	0.134
ECN: E20-0684-Rev. D, 28 DWG: 6021	3-Dec-2020	·	·	

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